

## AS1747, AS1748, AS1749, AS1750 Low-Voltage, Dual SPDT, Audio Clickless Switches with Negative Rail Capability

## 1 General Description

The SPDT (single-pole/double-throw) switches AS1747, AS1748, AS1749 and AS1750 allow signals below ground to pass through without distortion. These analog switches are ideal for switching audio signals, due to their supply voltage from +1.8V to +5.5V and their low  $0.4\Omega$  on-resistance.

An included comparator offers the AS1748 and AS1750 with headphone detection or mute/send key function.

To reduce click-and-pop sounds when switching between pre-charged points the AS1749 and AS1750 have an internal shunt switch. This shunt switch automatically discharges any capacitance at the NO and NC connection points.

This SPDT switch is available in space-saving 10-pin TDFN 3x3 packages and operate over the -40°C to +85°C extended temperature range.

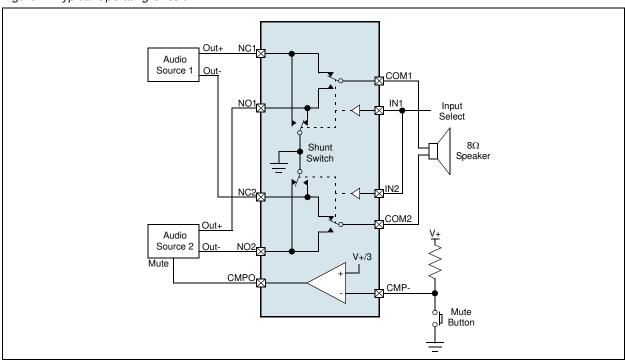
### 2 Key Features

- Distortion -Free Negative Signal Throughput Down to Vcc - 5.5V
- Comparator for Headphone or Mute Detection (AS1748/AS1750)
- Internal Shunt Resistor Reduces Click/Pop (AS1749/AS1750)
- Low On-Resistance (R<sub>ON</sub>)
   0.4Ω at +2.7V Supply
- 0.25Ω On-Resistance Flatness
- 0.03Ω On-Resistance Matching
- +1.8V to +5.5V Supply Voltage
- -90dB Crosstalk (100kHz)
- -65dB Off-Isolation (100kHz)
- 0.01% Total Harmonic Distortion
- Available in 10-pin TDFN 3x3, 16-pin TQFN 3x3, and 12-Bump WL-CSP Packages

## 3 Applications

The device is ideal for cell phones, PDAs and hand-held devices, notebook computers and MP3 players.

Figure 1. Typical Operating Circuit

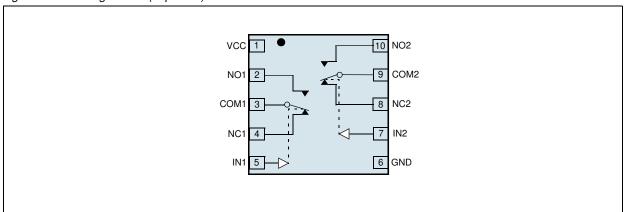




## 4 Pinout

#### **Pin Assignment**

Figure 2. Pin Assignments (Top View) for AS1747/AS1749



#### **Pin Description**

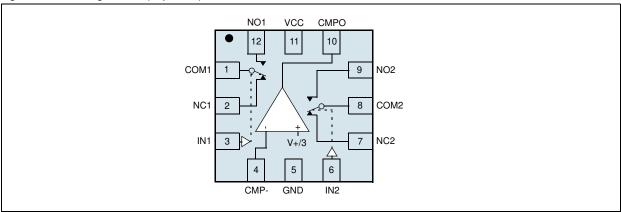
Table 1. Pin Description for AS1747/AS1749

Pin Name	TDFN	Description		
Vcc	1	Positive-Supply Voltage Input		
NO1	2	nalog Switch 1 - Normally Open Terminal		
COM1	3	Analog Switch 1 - Common Terminal		
NC1	4	Analog Switch 1 - Normally Closed Terminal		
IN1	5	Digital Control Input for Analog Switch 1. A logic LOW on IN1 connects COM1 to NC1 and a logic HIGH connects COM1 to NO1.		
GND	6	Ground		
IN2	7	Digital Control Input for Analog Switch 2. A logic LOW on IN2 connects COM2 to NC2 and a logic HIGH connects COM2 to N02.		
NC2	8	Analog Switch 2 - Normally Closed Terminal		
COM2	9	Analog Switch 2 - Common Terminal		
NO2	10	Analog Switch 2 - Normally Open Terminal		
EP	EP (TDFN only)	Exposed pad for TDFN package. Connect to GND.		



#### **Pin Assignment**

Figure 3. Pin Assignments (Top View) for AS1748/AS1750



### **Pin Description**

Table 2. Pin Description for AS1748/AS1750

Pin Name	TQFN	Description	
COM1	1	Analog Switch 1 - Common Terminal	
NC1	2	nalog Switch 1 - Normally Closed Terminal	
IN1	3	Digital Control Input for Analog Switch 1. A logic LOW on IN1 connects COM1 to NC1 and a logic HIGH connects COM1 to NO1.	
CMP-	4	Comparator Inverting Input	
GND	5	Ground	
IN2	6	Digital Control Input for Analog Switch 2. A logic LOW on IN2 connects COM2 to NC2 and a logic HIGH connects COM2 to NO2.	
NC2	7	Analog Switch 2 - Normally Closed Terminal	
COM2	8	Analog Switch 2 - Common Terminal	
NO2	9	Analog Switch 2 - Normally Open Terminal	
CMPO	10	Comparator Output	
Vcc	11	Positive-Supply Voltage Input	
NO1	12	Analog Switch 1 - Normally Open Terminal	
EP	EP	Exposed pad. Connect to GND.	



# 5 Absolute Maximum Ratings

Stresses beyond those listed in Table 3 may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in Electrical Characteristics on page 5 is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 3. Absolute Maximum Ratings

Parameter	Min	Max	Units	Comments
Vcc, IN_, CMP-	-0.3	+6.0	V	
COM_, NO_, NC_	Vcc - 6	Vcc + 0.3	V	
CMPO	0.3	Vcc + 0.3	V	
Closed-Switch Continuous Current COM_, NO_, NC_		±150	mA	
Open-Switch Continuous Current NO_, NC_ (AS1749/AS1750)		±30	mA	
Peak Current COM_, NO_, NC_ (pulsed at 1ms, 10% duty cycle)		±400	mA	
Continuous Power Dissipation (T <sub>A</sub> = +70°C)	•			
10-pin TDFN 3x3 (derate 24.4mW/ºC above +70ºC)		1951	mW	
12-Bump WL-CSP (AS1747/AS1749) (derate 5.6mW/°C above +70°C)		449	mW	
12-Bump WL-CSP (AS1748/AS1750) (derate 6.5mW/°C above +70°C)		519	mW	
16-pin TQFN 3x3 (derate 16.9mW/ºC above +70ºC)		1349	mW	
ESD		2	kV	HBM MIL-Std. 883E 3015.7 methods
Latchup Immunity	-200	+200	mA	@25°C, <i>JEDEC 78</i>
Operating Temperature Range	-40	+85	ōC	
Junction Temperature		+150	ōC	
Storage Temperature Range	-65	+150	ōC	
Package Body Temperature		+260	<sup>©</sup> C	The reflow peak soldering temperature (body temperature) specified is in accordance with IPC/JEDEC J-STD-020D "Moisture/Reflow Sensitivity Classification for Non-Hermetic Solid State Surface Mount Devices".  The lead finish for Pb-free leaded packages is matte tin (100% Sn).



#### **6 Electrical Characteristics**

VCC = +2.7V to +5.5V,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise specified. Typical values are at VCC = +3.0V,  $T_A = +25^{\circ}C$ , unless otherwise specified.

Table 4. Electrical Characteristics

Symbol	Parameter	Condition		Min	Тур	Max	Unit
Analog Sw	ritch						
V <sub>NO</sub> _ V <sub>NC</sub> _ V <sub>COM</sub> _	Analog Signal Range			Vcc - 5.5		Vcc	V
R <sub>ON(NC)</sub>		Vcc = 2.7V; V <sub>NC</sub> or V <sub>NO</sub> =	T <sub>A</sub> = +25 <sup>o</sup> C		0.4	0.85	
R <sub>ON(NO)</sub>	On-Resistance	Vcc - 5.5V, -1V, 0V, 1V, 2V, Vcc; I <sub>COM</sub> _ = 100mA	$T_A = T_{MIN}$ to $T_{MAX}$			0.95	Ω
	On-Resistance Match	$VCC = 2.7V$ , $V_{NC}$ or $V_{NO} =$	T <sub>A</sub> = +25 <sup>o</sup> C		0.03	0.1	
ΔR <sub>ON</sub>	Between Channels	0V, I <sub>COM</sub> = 100mA	$T_A = T_{MIN}$ to $T_{MAX}$			0.15	Ω
	On-Resistance	$VCC = 2.7V; V_{NC} \text{ or } V_{NC} = -$	T <sub>A</sub> = +25 <sup>o</sup> C		0.25	0.4	
R <sub>FLAT(NC)</sub>	Flatness	1V, 0V, 1V, 2V, Vcc; I <sub>COM</sub> = 100mA	$T_A = T_{MIN}$ to $T_{MAX}$			0.45	Ω
R <sub>SH</sub>	Shunt Switch Resistance	AS1749/AS1750 only, $I_{NO}$ or $I_{NC}$ = 10mA, Vcc = 2.7V	$T_A = T_{MIN}$ to $T_{MAX}$		25	50	Ω
		AS1747/AS1748 only,	T <sub>A</sub> = +25°C	-10		+10	
INO_(OFF) INC_(OFF)	NO_, NC_ Off-Leakage Current	$V_{CC} = 2.7V$ , switch open; $V_{NC}$ or $V_{NO} = -2.5V$ , +2.5V; $V_{COM} = +2.5V$ , -2.5V	$T_A = T_{MIN}$ to $T_{MAX}$	-200		+200	nA
	0014	Vcc = 2.7V, switch closed;	T <sub>A</sub> = +25°C	-10		+10	
ICOM_(ON)	COM_ On-Leakage Current	$V_{NC}$ or $V_{NO}$ = -2.5V, +2.5V; or floating; $V_{COM}$ = -2.5V, +2.5V, or floating	$T_A = T_{MIN}$ to $T_{MAX}$	-200		+200	+200 nA
Dynamic C	Characteristics						
	_	V <sub>NO</sub> = 2.5V; for NO_, V <sub>IN</sub> _ = 0V to V <sub>CC</sub> ; for NC_, V <sub>IN</sub> _ =	T <sub>A</sub> = +25 <sup>o</sup> C		200	400	
ton	Turn-On Time <sup>1</sup>	Vcc to 0V; $R_L = 300\Omega$ , $C_L = 35pF$ , Figure 19	$T_A = T_{MIN}$ to $T_{MAX}$			400	ns
		V <sub>NC</sub> = 2.5V; for NO_, V <sub>IN</sub> _ =	T <sub>A</sub> = +25 <sup>o</sup> C		50	200	
t <sub>OFF</sub>	Turn-Off Time <sup>1</sup>	Vcc to 0V; for NC_, ViN_ = 0V to Vcc; R <sub>L</sub> = $300\Omega$ , C <sub>L</sub> = $35$ pF, Figure 19	$T_A = T_{MIN}$ to $T_{MAX}$			200	ns
t <sub>D</sub>	Break-Before-Make Time Delay	$V_{N\_}$ = 2.5V, for NO_, $V_{N\_}$ = Vcc to 0V; for NC_, $V_{N\_}$ = 0V to Vcc; $R_L$ = 300 $\Omega$ , $C_L$ = 35pF, Figure 20			200		ns
Q	Charge Injection	$V_{COM} = 0V$ , $R_S = 0\Omega$ , $C_L = 1.0$ nF, Figure 21			2		рС
V <sub>ISO</sub>	Off-Isolation	$V$ CC = 5V, f = 100kHz, $V$ COM_ = 1 $V$ RMS, $R$ L = 50 $\Omega$ , $C$ L = 5pF, Figure 22			-65		dB
V <sub>CT</sub>	Crosstalk	$Vcc = 5V$ , $f = 100kHz$ , $V_{COM}$ $50\Omega$ , $C_L = 5pF$ , Fig		-90		dB	
PSRR	Power-Supply Rejection Ratio	$f = 10kHz, V_{COM} = 1V_{RMS}, R$	$_{L} = \overline{50\Omega}, C_{L} = 5pF$		70		dB
BW	On-Channel-3dB Bandwidth	Vcc = 5V, Signal = 0dBm, R <sub>L</sub> Figure 22	= $50\Omega$ , $C_L = 5pF$ ,		31		MHz



Table 4. Electrical Characteristics (Continued)

Symbol	Parameter	Condition		Min	Тур	Max	Unit
THD	Total Harmonic Distortion	$f = 20$ Hz to $20$ kHz, $V_{COM} = 0$ 0, $R_L = 32\Omega$	.5V <sub>P-P</sub> , DC Bias =		0.01		%
C <sub>NO_(Off)</sub> C <sub>NC_(Off)</sub>	NO_, NC_ Off- Capacitance	f = 1MHz, V <sub>COM</sub> _ = 0.5V <sub>P</sub> -	P, DC Bias = 0		63		pF
C <sub>COM_(ON)</sub>	COM On-Capacitance	f = 1MHz, V <sub>COM</sub> _ = 0.5V <sub>P</sub> -	P, DC Bias = 0		196		pF
Digital I/O	(IN_)						
VIH	Input Logic High	Vcc = 2.7V to 3	3.6V	1.4			.,
VIH	Voltage	Vcc = 4.2V to 5	5.5V	2.0			V
1/11	Input Logic Low	Vcc = 2.7V to 3	3.6V			0.5	.,
VIL	Voltage	Vcc = 4.2V to 5	5.5V			0.8	0.8 V
lin	Input Leakage Current	$VIN_= 0V$ to $VCC$ , $VCC = 5.5V$		-1		+1	μΑ
Comparato	or (AS1748/AS1750)						
	Comparator Threshold				Vcc/3		V
	Comparator Output High Voltage	Isource = 1m	nA	Vcc - 0.45V			V
	Comparator Output Low Voltage	I <sub>SINK</sub> = 1mA				0.4V	V
	Comparator Input Leakage Current	V <sub>CMP-</sub> = 0 to 2.	$V_{CMP-} = 0 \text{ to } 2.7V$			+50	nA
	Comparator Switching Time	VCC = 2.7V, $V_{CMP-}$ = 0V to VCC, from 50% of $V_{CMP-}$ to 50% of $V_{CMPO}$			0.3	0.4	μs
Power Sup	pply						
Vcc	Power-Supply Range			1.8		5.5	V
loo	Committee Committee	Voc. 5 5 // Vol. 0 // -:: Voc.	AS1747/AS1749		0.01	1	^
Icc	Supply Current	$VCC = 5.5V$ , $VIN_{-} = 0V$ or $VCC$	AS1748/AS1750		5	10	μΑ

#### 1. Guaranteed by design

**Note:** All limits are guaranteed. The parameters with min and max values are guaranteed with production tests or SQC (Statistical Quality Control) methods.



# 7 Typical Operating Characteristics

VCC = 3.0V,  $T_A = +25^{\circ}C$  (unless otherwise specified).

Figure 4. ON-Resistance vs. Vcom

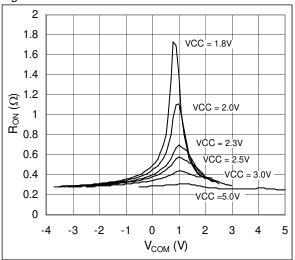


Figure 6. ON Resistance vs. Vcoм; Vcc=5.0V

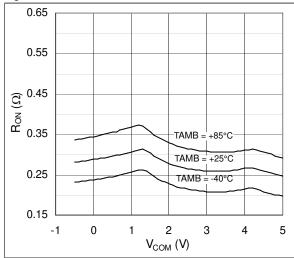


Figure 8. Icc vs. Vcc; AS1748/AS1750

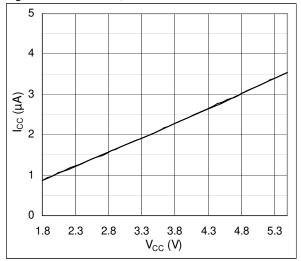


Figure 5. ON Resistance vs. Vcoм; Vcc=3.0V

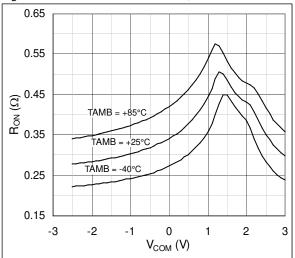


Figure 7. Icc vs. Vcc; AS1747/AS1749

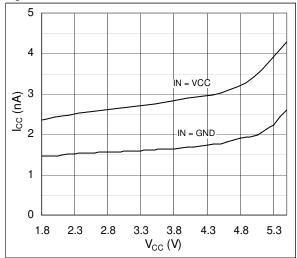


Figure 9. Turn-ON/OFF Times vs. Vcc

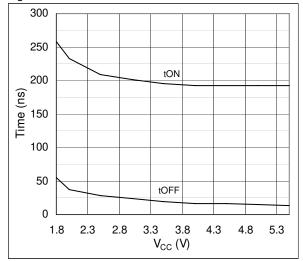




Figure 10. Turn-ON/OFF vs. Temperature; Vcc = 3V

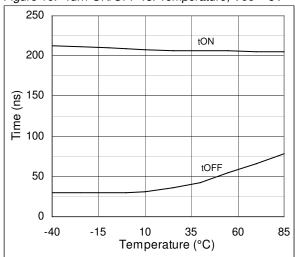


Figure 11. Logic Threshold Voltage vs. Vcc

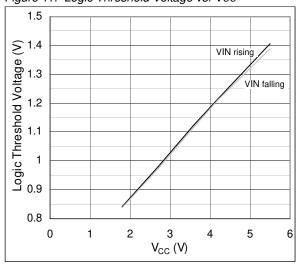


Figure 12. Charge Injection vs. VCOM; CLOAD = 1nF

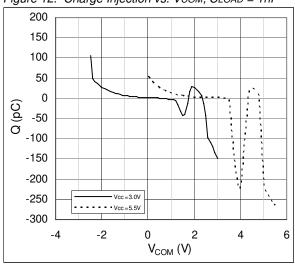


Figure 13. Leakage Current vs. Temperature

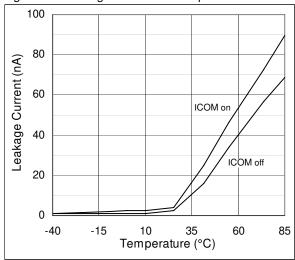


Figure 14. Frequency Response

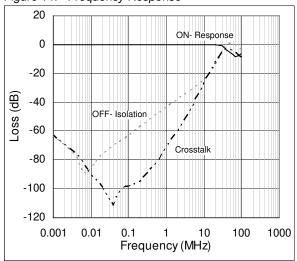


Figure 15. Total Harmonic Distortion vs. Frequency

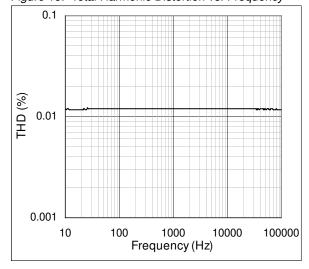




Figure 16. Comparator Threshold vs. Temperature; Vcc = 3.0V

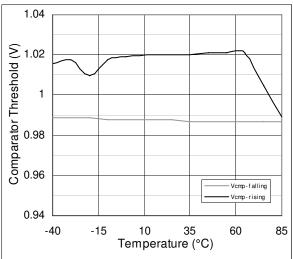


Figure 17. Comparator Threshold vs. Temperature; VCC = 5.0V

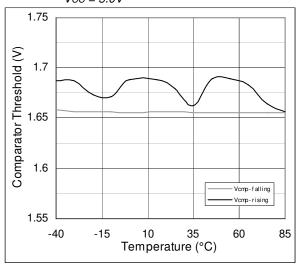
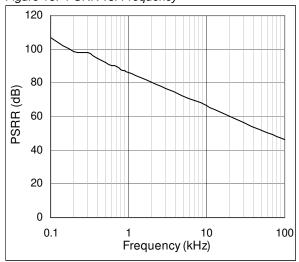


Figure 18. PSRR vs. Frequency





## 8 Detailed Description

The AS1747– AS1750 are operating from a +1.8V to +5.5V supply and feature a negative signal capability that allows signals below ground to pass through without distortion. A break-before-make switching and a low on-resistance are also included in this analog dual SPDT switches. The device is fully specified for a 3.0V application.

A headphone or mute detection is included in the AS1748 and AS1750. This function is realized with a comparator which has an internally generated thresh-hold of about 1/3 of Vcc. To reduce click-and-pop sounds when switching between precharged points the AS1749 and AS1750 have an internal shunt switch. This shunt switch automatically discharges any capacitance at the NO and NC connection points.

### 9 Application Information

#### **Digital Control Inputs**

The logic inputs of the AS1747– AS1750 accept up to +5.5V independent of the supply voltage. Due to this a mixing of the logic levels in a system is possible. For example, with a +3.3V supply, IN\_ can be driven low to GND and high to +5.5V. For a +1.8V supply voltage, the logic levels are 0.5V (low) and 1.4V (high); for a +5V supply voltage, the logic levels are 0.8V (low) and 2.0V (high).

#### **Analog Signal Levels**

The change of the on-resistance of the AS1747– AS1750 is very little for analog input signals over the whole supply voltage range. The switches are bi-directional, so the NO\_, NC\_, and COM\_ pins can be either inputs or outputs.

The AS1747– AS1750 pass signals as low as Vcc - 5.5V, including signals below ground with minimal distortion.

# **Comparator (AS1748** 1/AS1750)

To implement a mute and headphone function, a comparator is included in the AS1748 and AS1750. The negative terminal of this comparator is connected to the outside (via pin CMP-) while the positive terminal is internally set to Vcc/3. The output of the comparator (CMPO) is logic high when the negative terminal (CMP-) is below the threshold. CMPO is logic low when CMP- is higher than Vcc/3.

Headphone audio signals are typical biased to Vcc/2 so a comparator threshold of Vcc/3 is sufficient for the headphone detection.

# Shunt Switch (AS1749<sup>1</sup>/AS1750)

Due to the switching between audio sources, audible click-and-pop sounds occur. To reduce this sounds a  $100\Omega$  shunt switch is implemented in the AS1749 and AS1750. This shunt switch automatically discharges any capacitance at the NC\_ or NO\_ terminals when they are unconnected to COM\_.

Audible clicks and pops are caused when a step DC voltage is switched into the speaker. By automatically discharging the side that is not connected, any residual DC voltage is removed, thereby reducing the clicks and pops.

### **Power-Supply Sequencing and Overvoltage Protection**

**Caution:** Stresses beyond the listed absolute maximum ratings in Table 3 on page 4 may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Proper power-supply sequencing is recommended for all CMOS devices. Always apply Vcc before applying analog signals, especially if the analog signal is not current-limited.

1.	Ωn	reo	uest
1.	OH	100	ucsi



# **10 Timing Diagrams**

Figure 19. Switching Time

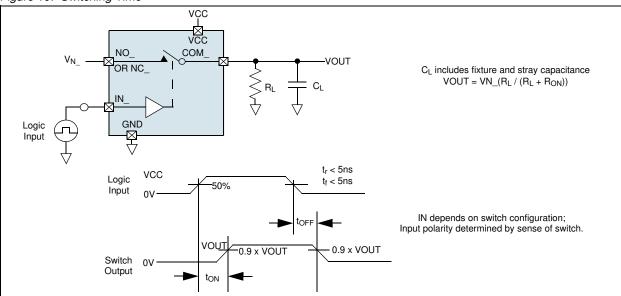


Figure 20. Break-Before-Make Interval

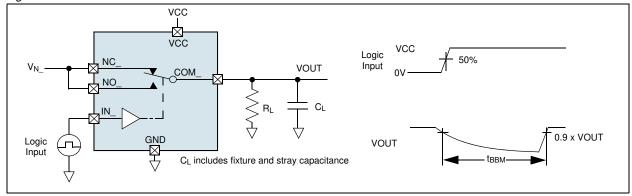


Figure 21. Charge Injection

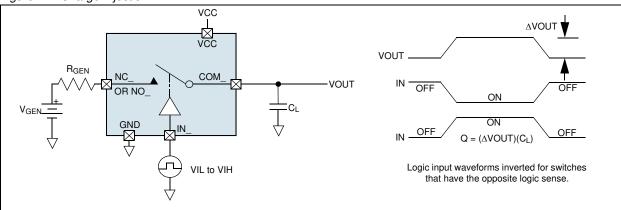
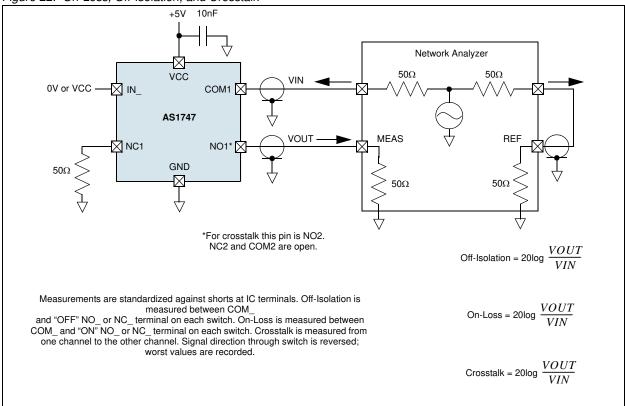




Figure 22. On-Loss, Off-Isolation, and Crosstalk

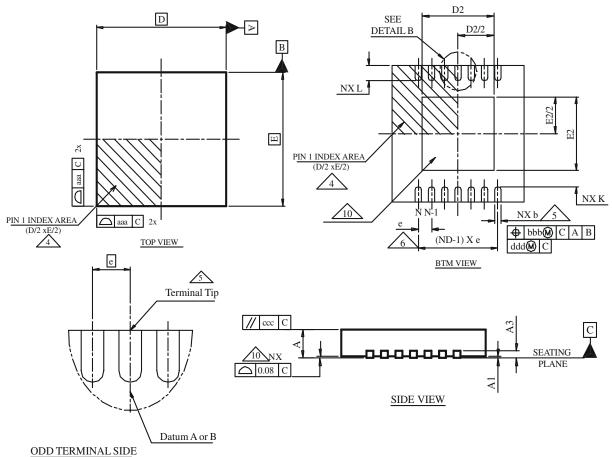




# 11 Package Drawings and Markings

The devices are available in 10-pin TDFN 3x3, 16-pin TQFN 3x3 package.

Figure 23. 10-pin TDFN 3x3 Package Dimensions



Symbol	Min	Nom	Max	Notes
Α	0.70	0.75	0.80	
A1	0.00	0.02	0.05	
A3		0.20 REF		
θ	0 <sub>0</sub>		14⁰	
aaa		0.15		
bbb		0.10		
CCC		0.10		
ddd	0.05			
eee	0.08			
ggg		0.10		

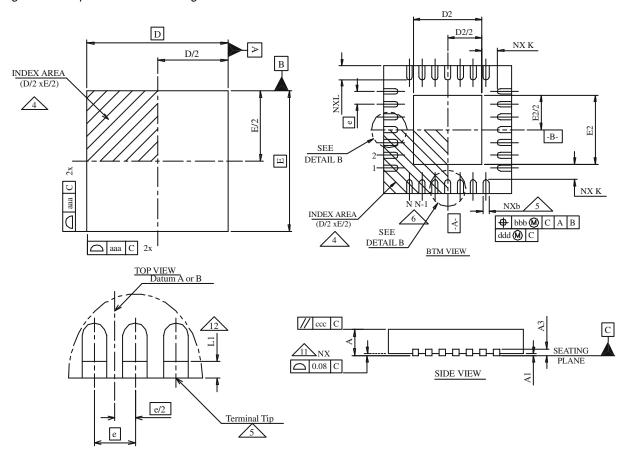
Symbol	Min	Nom	Max	Notes
D BSC		3.00		
E BSC		3.00		
D2	2.20		2.70	
E2	1.40		1.75	
L	0.30	0.40	0.50	
K	0.20			
b	0.18	0.25	0.30	
е		0.50		
N	10	N	10	
ND	5	ND	5	

#### Notes:

- 1. All dimensions are in millimeters, angle is in degrees.
- 2. N is the total number of terminals.
- 3. ND refers to the maximum number of terminals on D side.



Figure 24. 16-pin TQFN 3x3 Package Dimensions



EVEN TERMINAL SIDE

Symbol	Min	Nom	Max	Notes	
Α	0.70	0.75	0.80		
A1	0.00	0.02	0.05		
А3		0.20 REF			
L1	0.03		0.15		
b	0.18	0.25	0.30		
е		0.50			
aaa		0.15			
bbb					
ccc	0.10				
ddd		0.05			

Symbol	Min	Nom	Max	Notes
K	0.20	1.45		
D BSC		3.00		
E BSC		3.00		
D2	1.30	1.45	1.55	
E2	1.30	0.40	1.55	
L	0.30	0.40	0.50	
N		16		
ND				
NE		4		



# 12 Ordering Information

The devices are available as the standard products shown in Table 5.

Table 5. Ordering Information

Ordering Code	Marking	Description	Delivery Form	Package
AS1747-BTDT	ASPV	Dual 0.60hm SPDT, Audio Clickless Switch with Negative Rail Capability	Tape and Reel	10-pin TDFN 3x3
AS1747-BTDR*	ASPV	Dual 0.60hm SPDT, Audio Clickless Switch with Negative Rail Capability	Tray	10-pin TDFN 3x3
AS1747-BWLT*	ASPV	Dual 0.60hm SPDT, Audio Clickless Switch with Negative Rail Capability	Tape and Reel	10-Bump WL-CSP
AS1748-BQFT*	ASPW	Dual 0.6Ohm SPDT, Audio Clickless Switch with Negative Rail Capability, with Comparator	Tape and Reel	16-pin TQFN 3x3
AS1748-BQFR*	ASPW	Dual 0.6Ohm SPDT, Audio Clickless Switch with Negative Rail Capability, with Comparator	Tray	16-pin TQFN 3x3
AS1748-BWLT*	ASPW	Dual 0.60hm SPDT, Audio Clickless Switch with Negative Rail Capability, with Comparator	Tape and Reel	12-Bump WL-CSP
AS1749-BTDT*	ASPX	Dual 0.6Ohm SPDT, Audio Clickless Switch with Negative Rail Capability, with Internal Shunt	Tape and Reel	10-pin TDFN 3x3
AS1749-BTDR*	ASPX	Dual 0.6Ohm SPDT, Audio Clickless Switch with Negative Rail Capability, with Internal Shunt	Tray	10-pin TDFN 3x3
AS1749-BWLT*	ASPX	Dual 0.6Ohm SPDT, Audio Clickless Switch with Negative Rail Capability, with Internal Shunt	Tape and Reel	10-Bump WL-CSP
AS1750-BQFT	ASPY	Dual 0.6Ohm SPDT, Audio Clickless Switch with Negative Rail Capability, with Comparator & Internal Shunt	Tape and Reel	16-pin TQFN 3x3
AS1750-BQFR*	ASPY	Dual 0.6Ohm SPDT, Audio Clickless Switch with Negative Rail Capability, with Comparator & Internal Shunt	Tray	16-pin TQFN 3x3
AS1750-BWLT*	ASPY	Dual 0.60hm SPDT, Audio Clickless Switch with Negative Rail Capability, with Comparator & Internal Shunt	Tape and Reel	12-Bump WL-CSP

<sup>\*</sup> on request

Note: All products are RoHS compliant and Pb-free.

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